

NT25L59-DTF8S NT25L59-GRP6

PRODUCT / PROCESS CHANGE NOTIFICATION

PCN-000582

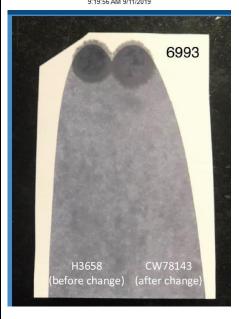
Date: Sep 19 2019 P1/2

Semtech Corporation, 200 Flynn Road, Camarillo CA 93012							
Semtech Canada Corporation, 4281 Harvester Road, Burlington, Ontario L7L 5M4 Canada							
Semtech Irvine, 5141 California Ave., Suite 100, Irvine CA 92617							
Semtech Neuchatel Sarl, Route des Gouttes d'Or 40, CH-2000 Neuchatel Switzerland							
Semtech Bristol - EMEA Limited, Block B, St James Court, Great Park Road, Bristol BS32 4QJ, UK							
Semtech Corpus Christi SA de CV, Carretera Matamorros Edificio 7, Reynosa, Tamaulipas, Mexico 88780							
Semtech Plano, 1101 Resource Drive, Suite 121, Plano TX 75074							
Change Details							
Part Number(s) Affected:	Customer Part Number(s) Affected: ⊠ N/A						
NT20067-GRP6	, ,						
NT20R67-DTF8S							
NT20R67-GRP6							
NT23L50-GRP6							
NT24L50-GRP6							
NT24L50-DTF8S							
GN25L53-GRP6							
GN25L53B-GRP6							
NT22030-DTF8S							
NT25L51-GRP6							

Description, Purpose and Effect of Change:

Supplier of 6993 black ink, used for identification of defective die on wafer, is changing composition of the ink: Removed Bisphenol A to meet EU REACH SVHC requirements EC# 201-245-8.

There is no significant deference in ink appearance, no difference in adhesion, therefore no negative effect. 9:19:56 AM 9/11/2019





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P2/2

Change Classification			☐ Major ☑ Minor			pact to Fo		⊠ Yes □ No			
Impact to Data Sheet			☐ Yes ⊠ No			w Revisior	or Date	⊠ N/A			
Impact to Performance, Characteristics or Reliability: This change does not affect product performance, characteristics, reliability. 921-40 AM 9/11/2019											
	Characteristic		Specification	9:21:40 AM 9	9/11/2019 Lot CW78143 (after						
	Viscosity	620-720 c	(not changed)	(before change	ge) change) 660 cPs		Comments				
	Initial Dot Size	279-457 μ (11-18 mil	ım	326 μm (12.85 mils)	304	4 μm 20 dots dispensed with DM-1 15 Mil @ 2.00 mils)		with DM-1 15 Mil @ 6 dps			
	Dot Size Variation	≤ 25 µm ra (≤1 mil rar				μm 00 mils)	20 dots dispensed with DM-1 15 Mil @ 6 dps				
	Dot Structure	Round & c	consistent	Round & consiste	ent Rou	nd & consistent	20 dots dispensed	with DM-1 15 Mil @ 6 dps			
	Dot Size Difference Between Inking Rates		ifference between 1 and 6 nd rate ≤ 89 μm (≤ 3.5 mils)	23 μm (0.90 mils)	25 μ	ım (1.00 mils)	Dispensed from DN	Л-1 15 Mil			
	Dot Size After 5 Minute Inking Pause	≤ 482 μm (≤ 19 mils))	406 μm (16 mils)	381	μm (15 mils)	Dispensed from DN	Л-1 15 Mil			
	Fineness of Grind	Streaks = 0 Backgroun		Streaks = 0 Background = 8		aks = 0 kground = 8					
	Adhesion Test	Passes tap	oe test with no cracking or	Passed	Pas	sed		Pass/Fail test; minimum 100 dots sampled. Cured at 100 °C for 5 minutes.			
	Sodium (Na) Level	Not Specif	fied	< 2.0 ppm	< 2.	0 ppm					
	Chloride (Cl) Level	Not Specif	fied	330 ppm	320	ppm					
Implementation Date			Sept-30-20)19		Work W		WW40			
Last Time Ship (LTS) Of unchanged product				Affecting Lot No. / Serial No. (SN)							
Sample Availability			Yes	Qualification Report Availability			Yes				
Supporting Documents for Change Validation/Attachments: • Certificate of conformance											
Issuing Authority											
Semt	ech Business l	Jnit:		Signal Integrity Products							
Semtech Contact Info:			Dusanka Hewlett QMS Engineer, Quality Assurance Semtech Canada Corporation 4281 Harvester Road Burlington, ON L7L 5M4 Canada 289-856-9272 dhewlett@semtech.com				Hawlett				
FOR FURTHER INFORMATION & WORLDWIDE SALES COVERAGE: http://www.semtech.com/contact/index.html#support											